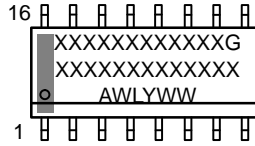


SOIC ĩ16 9.90x3.90x1.50 1.27P
CASE 751B
ISSUE L

SOIC i16 9.90x3.90x1.50 1.27P
CASE 751B
ISSUE L

DATE 29 MAY 2024

GENERIC
MARKING DIAGRAM*



XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
Y = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

<p>S 1: 1. C C ✓ 2. BAS ✓ 3. ✓ 4. C C ✓ 5. ✓ 6. BAS ✓ 7. C C ✓ 8. C C ✓ 9. BAS ✓ 10. ✓ 11. C C ✓ 12. ✓ 13. BAS ✓ 14. C C ✓ 15. ✓ 16. C C ✓</p>	<p>S 2: 1. CA ✓ 2. A ✓ 3. C C ✓ 4. CA ✓ 5. CA ✓ 6. C C ✓ 7. A ✓ 8. CA ✓ 9. CA ✓ 10. A ✓ 11. C C ✓ 12. CA ✓ 13. CA ✓ 14. C C ✓ 15. A ✓ 16. CA ✓</p>	<p>S 3: 1. C C , #1 ✓ 2. BAS , #1 ✓ 3. , #1 ✓ 4. C C , #1 ✓ 5. C C , #2 ✓ 6. BAS , #2 ✓ 7. , #2 ✓ 8. C C , #2 ✓ 9. C C , #3 ✓ 10. BAS , #3 ✓ 11. , #3 ✓ 12. C C , #3 ✓ 13. C C , #4 ✓ 14. BAS , #4 ✓ 15. , #4 ✓ 16. C C , #4 ✓</p>	<p>S 4: 1. C C , #1 ✓ 2. C C , #1 ✓ 3. C C , #2 ✓ 4. C C , #2 ✓ 5. C C , #3 ✓ 6. C C , #3 ✓ 7. C C , #4 ✓ 8. C C , #4 ✓ 9. BAS , #4 ✓ 10. , #4 ✓ 11. BAS , #3 ✓ 12. BAS , #3 ✓ 13. BAS , #2 ✓ 14. , #2 ✓ 15. BAS , #1 ✓ 16. , #1 ✓</p>
<p>S 5: 1. A , #1 ✓ 2. A , #1 ✓ 3. A , #2 ✓ 4. A , #2 ✓ 5. A , #3 ✓ 6. A , #3 ✓ 7. A , #4 ✓ 8. A , #4 ✓ 9. A , #4 ✓ 10. S C , #4 ✓ 11. A , #3 ✓ 12. S C , #3 ✓ 13. A , #2 ✓ 14. S C , #2 ✓ 15. A , #1 ✓ 16. S C , #1 ✓</p>	<p>S 6: 1. CA ✓ 2. CA ✓ 3. CA ✓ 4. CA ✓ 5. CA ✓ 6. CA ✓ 7. CA ✓ 8. CA ✓ 9. A ✓ 10. A ✓ 11. A ✓ 12. A ✓ 13. A ✓ 14. A ✓ 15. A ✓ 16. A ✓</p>	<p>S 7: 1. S C -C ✓ 2. C A () ✓ 3. C A () ✓ 4. A -C ✓ 5. C A () ✓ 6. C A () ✓ 7. C A () ✓ 8. S C -C ✓ 9. S C -C ✓ 10. C A () ✓ 11. C A () ✓ 12. C A () ✓ 13. A -C ✓ 14. C A () ✓ 15. C A () ✓ 16. S C -C ✓</p>	

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